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CONFIRMATION NO. 3021

<b>SERIAL NUMBER</b> 10/524,871	<b>FILING OR 371(c) DATE</b> 08/15/2005 <b>RULE</b>	<b>CLASS</b> 438	<b>GROUP ART UNIT</b> 2812	<b>ATTORNEY DOCKET NO.</b> MAT-3588
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## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

This application is a 371 of PCT/EP03/08220 07/25/2003

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

GERMANY 10236896.1 08/12/2002

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance	STATE OR COUNTRY GERMANY	SHEETS DRAWING 5	TOTAL CLAIMS 34	INDEPENDENT CLAIMS 3
Verified and Acknowledged	Examiner's Signature <i>m. Ahmad</i> Initials <i>MA</i>				

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## TITLE

Device and method for thermally treating semiconductor wafers

<b>FILING FEE RECEIVED</b> 1730	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
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